



\$5,000 3rd place



TI's Innovation Challenge Design Contest is now open to all accredited universities in the U.S., Puerto Rico, Mexico, and Canada. To compete, students must use 3 or more TI analog ICs in their design project or 2 analog ICs and a TI processor. Register for the contest early so we can help you start your design project with free tools and design support.

Step 1

Go to ti.com/tiic-na for complete rules and to see past winner's projects.

Step 2

Register and receive contest t-shirts and a \$200 TI eStore coupon.

Step 3

Submit your project.

Step 4

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